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PROVEN. RELIABLE. ADVANCED.

OUR COMPANY

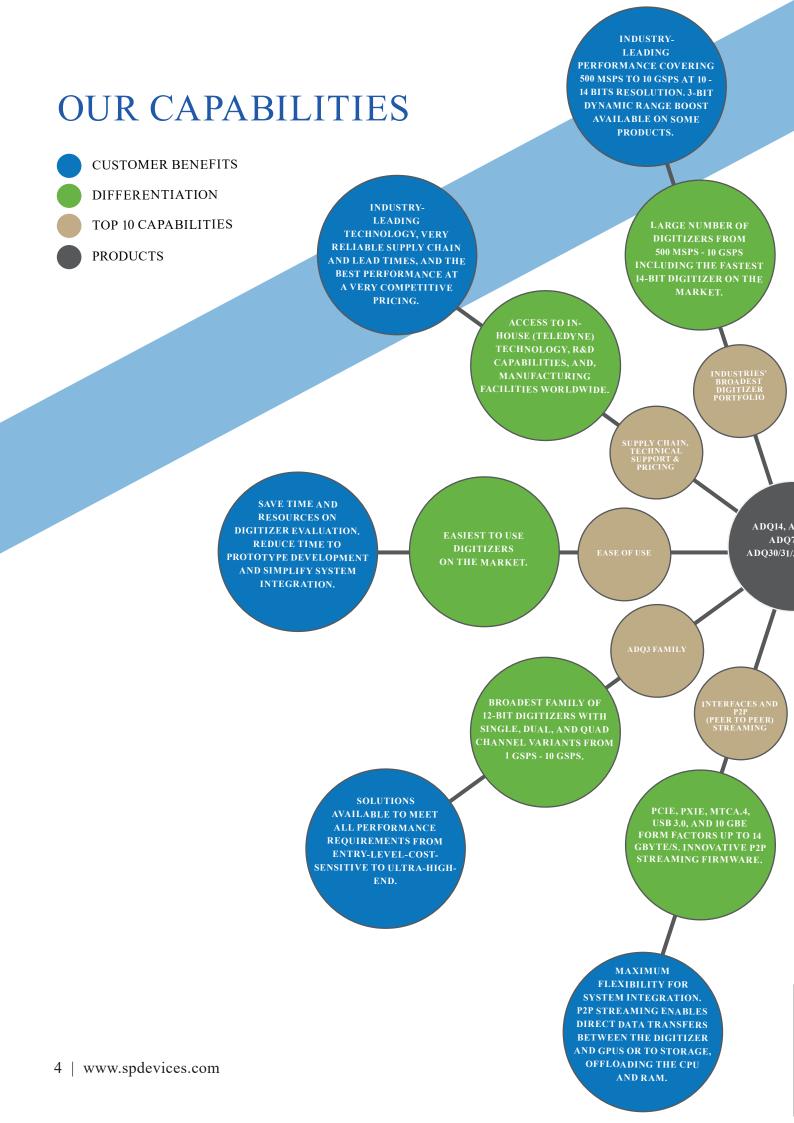
Teledyne SP Devices has provided digitizers to customers and original equipment manufacturers (OEMs) since 2004. We strive to be application experts in our target markets so that we can offer our customers differentiated features and capabilities to simplify and improve their system design.

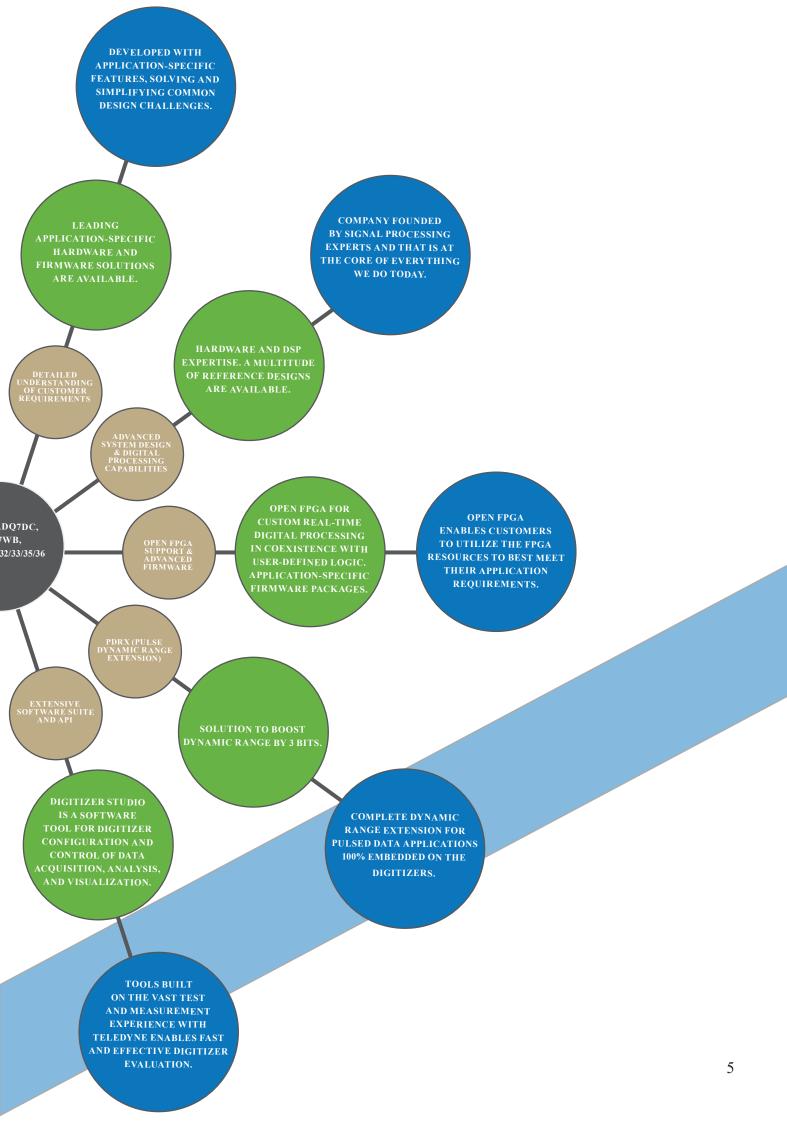
Our engineers make it their mission to provide leading-edge products constantly and consistently. We remain at the forefront of digitizing performance, by anticipating and adapting to ever-evolving technology, thus enabling our customers to deliver the most advanced and competitive products possible.

Teledyne SP Devices is part of Teledyne Technologies, an international, multi-billiondollar company. As a part of the Teledyne family, we have access to some of the industry's most knowledgeable experts, research and development capabilities, and manufacturing facilities worldwide.



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WHY TELEDYNE SP DEVICES

When you work with Teledyne SP Devices, you are also working with Teledyne Technologies. Therefore, we can ensure the most current products, technology, and solutions, but also offer the stability of a large supplier and a long-term partnership with our client.

Our product roadmap defines an offering that generates real and proven value, and our team of signal processing experts, applications team, and support staff work in close collaboration with our customers. We develop local engineering contacts to identify solutions, implement training, and facilitate integration milestones.

- The open architecture provides customer access to the onboard fieldprogrammable gate array (FPGA) for custom real-time signal processing.
- We offer custom engineering to our original equipment manufacturer (OEM) customers through design and integration services. All parts of the products can be customized, including software, firmware, and hardware. This allows our OEM customers to focus on their value-add.
- The applications team is part of our R&D organization and provides signal processing expertise as well as domain knowledge. They work in close collaboration with the customer during the design-in phase to fulfill integration milestones and thereby shorten the time to market.
- The in-house support group consists of experienced developers that work in close collaboration with our R&D team. They are directly involved in the planning of in-house R&D resources and can therefore escalate prioritized support cases so that they can be resolved in a timely manner. We take pride in providing short response times to our customers.

RODUCTS PRODUCTS MAKE A DIFFERENCE

Per Löwenborg, Ph.D. General Manager

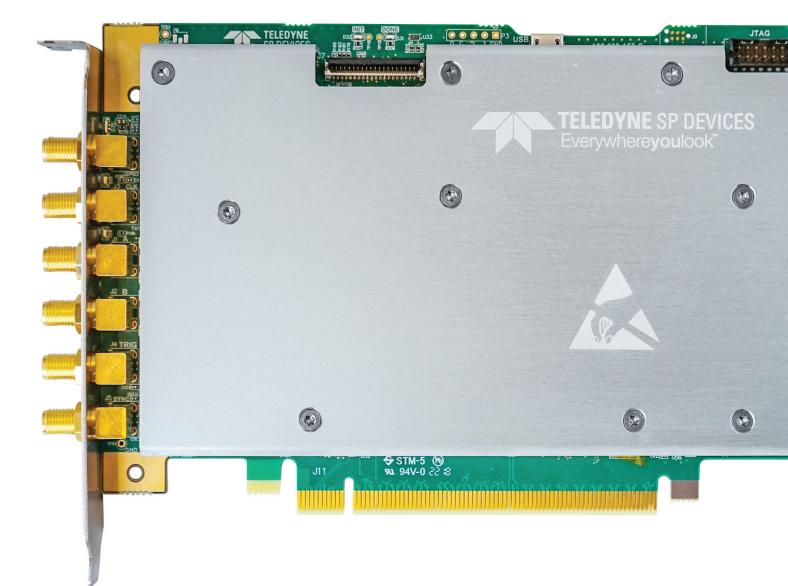
INSPIRING INNOVATION AND BREAKTHROUGHS

APPLICATION EXAMPLES

Teledyne SP Devices' digitizers are developed with applicationspecific features, solving and simplifying common design challenges.

- Time-of-flight mass spectrometry
- Distributed optical fiber sensing
- Swept-source OCT
- LiDAR
- ATE
- Big physics
- Automated test equipment
- Analytical instrumentation
- Quantum physics
- Aerospace & Defense
- and many more!





BREAKING BOUNDARIES TAKING YOU FORWARD

- Dual Gain Pulse Dynamic Range Extension (PDRX) boosts dynamic range by 3 bits
- Peer-to-peer streaming to GPU or SSD storage at rates up to 14 Gbyte/s
- Multiple digitizers can stream to the same GPU for aggregate rates up to 28 Gbyte/s
- Daisy-chain triggering for picosecond timing accuracy in high-channelcount systems operating at Giga sample per second sampling rates
- Easy-to-use application programming interface (API) that helps simplify development, code reuse, and maintenance

OUR PRODUCTS

Teledyne SP Devices offer high-performance digitizers using an open FPGA architecture, capable of enabling new applications. Our extensive product portfolio enables cost-optimized system-level solutions that meet the highest quality standards. Here are a few of the benefits:

- Hardware modules offer flexible operation by supporting AC- or DC-coupling, adjustable DC-offset, programmable input voltage range, advanced triggering, multi-channel synchronization, and more.
- All products support custom real-time DSP through an open FPGA architecture a crucial requirement for many of today's systems.
- Additional stand-alone firmware packages simplify operation by providing rich sets of application-specific functions without any need for firmware development.
- Data streaming of up to 14 Gbyte/s is supported, and selected products support peer-to-peer streaming to graphics processing units (GPUs) as well as to disk storage.
- Products are available in PCIe, PXIe, MTCA.4, USB 3.0, and 10 GbE form factors.



SELECTED PRODUCTS

ADQ7DC

14-bit, 10 GSPS Digitizer



Key Features

- 10 or 5 GSPS sampling rate with 14 bits resolution
- Single/Dual channel
- Open FPGA for custom real-time DSP
- Available in PXIe, PCIe, MTCA.4, USB 3.0, and 10 GbE form factors
- Multi-channel synchronization capabilities
- Peer-to-peer streaming to GPU or SSD
- Application-specific firmware helps shorten design time

Example Applications

- Time-of-flight mass spectrometry
- LiDAR
- RF sampling

ADQ14 14-bit, 2 GSPS Digitizer



Key Features

- 2, 1 or 0.5 GSPS sampling rate with 14 bits resolution
- Single/Dual/Quad channel
- Open FPGA for custom real-time DSP
- Available in PXIe, PCIe, MTCA.4, USB 3.0 and 10 GbE form factors
- Multi-channel synchronization capabilities
- Peer-to-peer streaming to GPU
- Application-specific firmware helps shorten design time

Example Applications

- Swept-source OCT
- LiDAR
- Distributed optical fiber sensing
- RF sampling

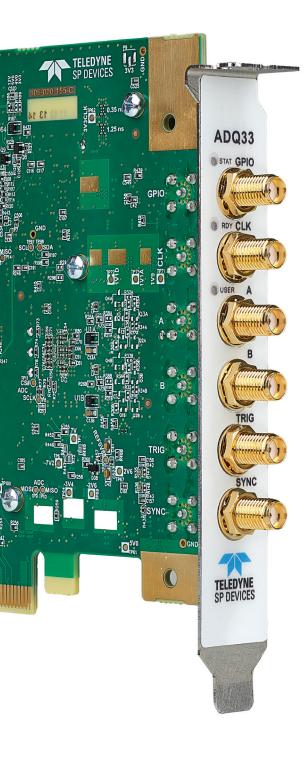
Digitizer Studio Evaluation Software



Key Features

- Offers quick access to the complete set of underlying API commands via an easy-to-use graphical user interface (GUI)
- Ideal tool for evaluation and integration
- New generation of software framework which can easily be updated with additional functionality
- Diagram view helps improve understanding of the underlying hardware architecture
- Powerful measurement, math, and graph functions
- Flexible control of a large number of digitizers in multi-channel installations
- Runs both on Windows and Linux

ADQ3X FAMILY



ADQ30 12-bit, 1 GSPS Digitizer



Key Features

- 1 GSPS sampling rate with 12 bits resolution
- Single channel
- Open FPGA for custom real-time DSP
- PCIe
- Multi-channel synchronization capabilities
- Peer-to-peer streaming to GPU
- Application-specific firmware helps shorten design time

Example Applications

- Time-of-flight mass spectrometry
- Distributed optical fiber sensing
- LiDAR

ADQ33 12-bit, 1 GSPS Digitizer



Key Features

- 1 GSPS sampling rate with 12 bits resolution
- Dual channel
- Open FPGA for custom real-time DSP
- PCIe
- Multi-channel synchronization capabilities
- Peer-to-peer streaming to GPU
- Application-specific firmware helps shorten design time

Example Applications

- Distributed optical fiber sensing
- Swept-source OCT
- LiDAR

ADQ32 12-bit, 5 GSPS Digitizer



Key Features

- 5 or 2.5 GSPS sampling rate with 12 bits resolution
- Single/Dual channel
- Open FPGA for custom real-time DSP
- PCIe
- Multi-channel synchronization capabilities
- Peer-to-peer streaming to GPU
- Application-specific firmware helps shorten design time

Example Applications

- Time-of-flight mass spectrometry
- Distributed optical fiber sensing
- Swept-source OCT

ADQ36 Evaluation Software



Key Features

- 5 or 2.5 GSPS sampling rate with 12 bits resolution
- Dual/Quad channel
- Open FPGA for custom real-time DSP
- PXIe
- Multi-channel synchronization capabilities
- Peer-to-peer streaming to GPU
- Application-specific firmware helps shorten design time

Example Applications

- LiDAR
- Beam position monitoring
- High energy physics

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 Self Declaration - Conforming to IS 13252 (Part 1): 2010, R-41003442

 工作站(微型计算机)
 額定电压: 100-240 V~

 产品型号:Dell Precision Tower 5810
 額定电流: 6 A

 频率: 50-60 Hz
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DELL V: 100-240 V- A 6 A Hz 50-60 Hz Reg Model D011 www.spdevices.com **G1**6 DPIN: SMJDW A00 EMP 001

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TECHNOLOGY

Teledyne SP Devices uses state-of-the-art components and the most recent design methodologies and tools in our R&D.

- Patented DSP solutions improve the performance of analog-to-digital converters (ADCs) beyond datasheet specifications:
 - ADX removes ADC time-interleaving errors to achieve unparalleled spurious-free dynamic range (SFDR). This is crucial in frequency-domain applications and provides an industry-leading dynamic range.
 - DBS corrects for baseline drift and pattern noise caused by temperature variations and component aging. It is used in time-domain applications and has contributed to significant advances in applications such as time-of-flight mass spectrometry and LiDAR.
- Every aspect of each product can be customized, enabling the reuse of existing infrastructure. This permits a cost-effective alternative to in-house development while keeping development cycles short.



MANUFACTURING & QUALITY FOCUS

As an ISO-certified company, we offer products that meet the highest quality standards. Our manufacturing capabilities and facilities provide complete quality, production, and test control.

- Teledyne SP Devices is ISO 9001-certified and all our development and manufacturing is performed according to well-established documented processes.
- Our primary Electronic Manufacturing Services (EMS) partner is a large well-renowned company that operates globally. They are both ISO 9001- and ISO 14001-certified and can produce thousands of units per month.
- Final assembly and testing are performed in-house to ensure compliance with specifications. Test result reports are created and stored automatically for each product.
- We offer traceable calibration via an accredited partner according to ISO 9001 and ISO/IEC 17025.



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